

#### **Product Features**

- ♦ Dual data-rate of 1.25Gbps/1.063Gbps operation
- ♦ TX1310nm FP laser
- ♦ RX1550 PIN photo detector for 20km transmission
- ♦ BIDI SC/UPC type pluggable optical interface
- ♦ Compliant with SFP MSA and SFF-8472 with simplex SC receptacle
- ♦ RoHS compliant and lead-free
- ♦ Single +3.3V power supply
- ♦ Support Digital Diagnostic Monitoring interface
- ♦ Case operating temperature Commercial: 0°C to +70°C

Extended: -10°C to +80°C Industrial: -40°C to +85°C



- ♦ Gigabit Ethernet
- ♦ Fiber Channel
- ♦ Switch to Switch interface
- ♦ Switched backplane applications
- ♦ Router/Server interface
- ♦ Other Optical Links

## **Ordering Information**

Part Number	Output Power	Rec. Sens	Data Rate	Wavelength	Distance
FH-SB3512CDS20					
FH-SB3512IDS20	-9 ~ -3 db	-25db	1.25G	TX1310/RX1550nm	20km





#### General

FH-SB3512CDS20 The SFP-BIDI transceivers are high performance, cost effective modules supporting dual data-rate of 1.25Gbps/1.0625Gbps and 20km transmission distance with SMF.

The transceiver consists of three sections: a DFB laser transmitter, a PIN photodiode integrated with a trans-impedance preamplifier (TIA) and MCU control unit. All modules satisfy class I laser safety requirements.

The transceivers are compatible with SFP Multi-Source Agreement (MSA) and SFF-8472. For further information, please refer to SFP MSA.

## **Absolute Maximum Ratings**

Parameter	Symbol	Min.	Max.	Unit	Note
Supply Voltage	Vcc	-0.5	4.0	V	
Storage Temperature		-40	85	°C	
Relative Humidity			85	%	

Note: Stress in excess of the maximum absolute ratings can cause permanent damage to the module

## **General Operating Characteristics**

Parameter	Symbol	Min.	Тур	Max.	Unit	Note
Data Rate			1250		Gb/s	
Supply Voltage	Vcc	3.13	3.3	3.47	V	
Supply Current	Icc <sub>5</sub>			220	mA	
Operating Case Temp.	Tc	0		70	°C	

#### FH-SB3512CDS20 1.25G WDM TX1310/RX1550 20KM DDMI SC

# **Electrical Input/Output Characteristics**

Parameter		Symbol	Min.	Тур	Max.	Unit	Note
Transmitter							
Diff. input voltage swing			120		820	mVpp	1
Ty Disable input	Н	VIH	2.0		Vcc+0.3	V	
Tx Disable input	L	VIL	0		0.8	V	
To Food out out	Н	VOH	2.0		Vcc+0.3	V	2
Tx Fault output	L	VOL	0		0.8		
Input Diff. Impe	Input Diff. Impedance			100		Ω	
Receiver							
Diff. output voltage swing			340	650	800	mVpp	3
Rx LOS Output	Н	VOH	2.0		Vcc+0.3	V	2
	L	VOL	0		0.8		2

Note 1) TD+/- are internally AC coupled with  $100\Omega$  differential termination inside the module.

Note 2) Tx Fault and Rx LOS are open collector outputs, which should be pulled up with 4.7k to  $10k\Omega$  resistors on the host board.

Pull up voltage between 2.0V and Vcc+0.3V.

Note 3) RD+/- outputs are internally AC coupled, and should be terminated with  $100\Omega$  (differential) at the user SERDES.

# **Optical Characteristics**

Parameter	Symbol	Min.	Тур	Max.	Unit	Note
Transmitter						
Operating Wavelength	λC	1270	1310	1350	nm	
Ave. output power (Enabled)	Ро	-9		-3	dBm	1
Extinction Ratio	ER	9			dB	1
RMS spectral width	Δλ			4	nm	
Rise/Fall time (20%~80%)	Tr/Tf			0.26	ps	2
Output Eye Mask	Compliant with IEEE802.3 z (class 1 laser safety)					



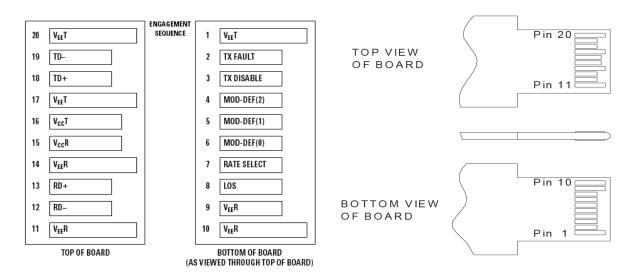
#### FH-SB3512CDS20 1.25G WDM TX1310/RX1550 20KM DDMI SC

Receiver						
Operating Wavelength		1530	1550	1570	nm	
Sensitivity	Psen			-24	dBm	3
Min. overload	Pimax	-3			dBm	
LOS Assert	Pa	-35			dBm	
LOS De-assert	Pd			-23	dBm	4
LOS Hysteresis	Pd-Pa	0.5		6	dB	

Note 1)Measure at 2^23-1 NRZ PRBS pattern

- 2) Transmitter eye mask definition
- 3) Measured with Light source 1550nm(1310nm), ER=9dB; BER =<10^-12 @PRBS=2^23-1 NRZ.
- 4) When LOS de-asserted, the RX data+/- output is signal output.

## **Pin Definitions And Functions**





#### FH-SB3512CDS20 1.25G WDM TX1310/RX1550 20KM DDMI SC

PIN#	Name	Function	Notes
1	VeeT	Tx ground	
2	Tx Fault	Tx fault indication, Open Collector Output, active "H"	1
3	Tx Disable	LVTTL Input, internal pull-up, Tx disabled on "H"	2
4	MOD-DEF2	2 wire serial interface data input/output (SDA)	3
5	MOD-DEF1	2 wire serial interface clock input (SCL)	3
6	MOD-DEF0	Model present indication	3
7	Rate select	No connection	
8	LOS	Rx loss of signal, Open Collector Output, active "H"	4
9	VeeR	Rx ground	
10	VeeR	Rx ground	
11	VeeR	Rx ground	
12	RD-	Inverse received data out	5
13	RD+	Received data out	5
14	VeeR	Rx ground	
15	VccR	Rx power supply	
16	VccT	Tx power supply	
17	VeeT	Tx ground	
18	TD+	Transmit data in	6
19	TD-	Inverse transmit data in	6
20	VeeT	Tx ground	

#### Notes:

- 1) When high, this output indicates a laser fault of some kind. Low indicates normal operation. And should be pulled up with a  $4.7 10 \mathrm{K}\Omega$  resistor on the host board.
- 2) TX disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a  $4.7 10 \text{K}\Omega$  resistor. Its states are:

Low (0 – 0.8V): Transmitter on

(>0.8, < 2.0V): Undefined

High (2.0V~Vcc+0.3V): Transmitter Disabled Open: Transmitter Disabled

3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a  $4.7K-10K\Omega$  resistor on the host board. The pull-up voltage shall be VccT or VccR.

Mod-Def 0 has been grounded by the module to indicate that the module is present

Mod-Def 1 is the clock line of two wire serial interface for serial ID

Mod-Def 2 is the data line of two wire serial interface for serial ID

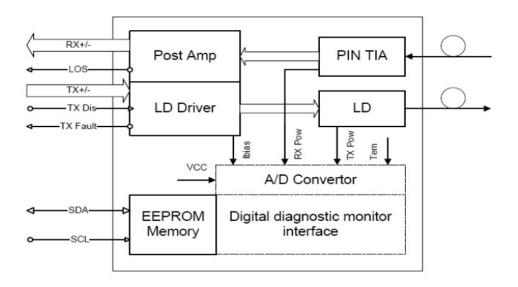


- 4) When high, this output indicates loss of signal (LOS). Low indicates normal operation.
- 5) RD+/-: These are the differential receiver outputs. They are AC coupled  $100\Omega$  differential lines which should be terminated with  $100\Omega$  (differential) at the user SERDES. The AC coupling is done inside the module and is thus not required on the host board.
- 6) TD+/-: These are the differential transmitter inputs. They are AC-coupled, differential lines with  $100\Omega$  differential termination inside the module. The AC coupling is done inside the module and is thus not required on the host board.

## **Diagnostics**

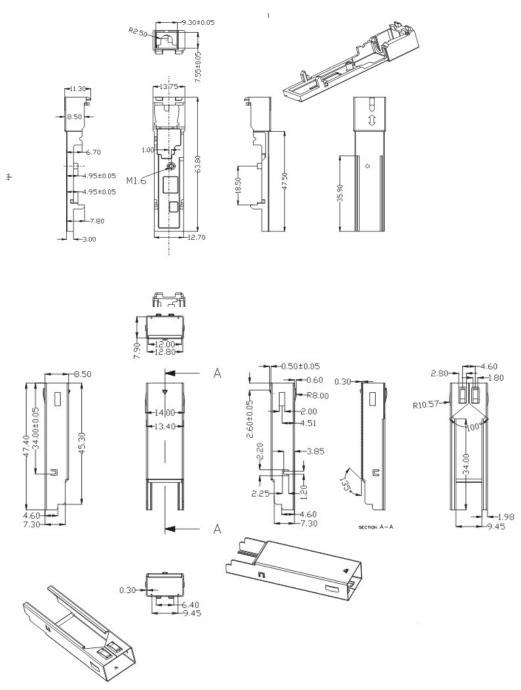
Parameter	Range	Unit	Accuracy	Calibration
Temperature	0 to +70 -40 to +85	°C	±3°C	Internal/ External
Voltage	3.0 to 3.6	V	±3%	Internal/ External
Bias Current	2 to 80	mA	±10%	Internal/ External
TX Power	-11 to -1	dBm	±3dB	Internal/ External
RX Power	-25 to 0	dBm	±3dB	Internal/ External

## **Functional Diagram**





# **Package Dimensions**





## **For More Information**

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